

# STGW40NC60W

## 40 A - 600 V - ultra fast IGBT

### Features

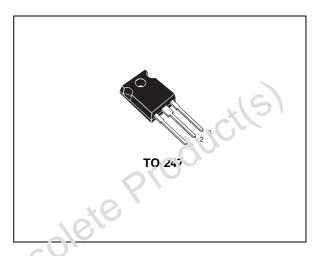
- Low C<sub>RES</sub> / C<sub>IES</sub> ratio (no cross conduction susceptibility)
- High frequency operation

### **Applications**

- High frequency inverters, UPS
- Motor drivers
- HF, SMPS and PFC in both hard switch and resonant topologies
- Welding
- Induction heating

## Description

This IGBT utilizes the advanced PowerMESF™ process resulting in an excellent trad:-off between switching performance or d low on-state behavior.



### Figure 1. Internal schematic diagram

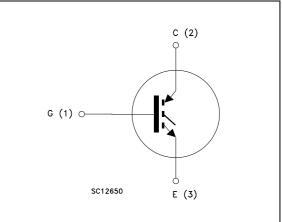


Table 1.	Device summary	1
	Borroo ourminary	

Order code	Marking	Package	Packaging
STGW40NC60W	GW40NC60W	TO-247	Tube

## Contents

1	Electrical ratings	
2	Electrical characteristics	
	2.1 Electrical characteristics (curves)	6
3	Test circuit	
4	Package mechanical data	
5	Revision history	12
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	dete	
	Electrical ratings	
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#### **Electrical ratings** 1

Table 2.	Absolute	maximum	ratings
	Absolute	maximum	raungs

Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-emitter voltage ( $V_{GE} = 0$ )	600	V
I <sub>C</sub> <sup>(1)</sup>	Collector current (continuous) at 25 °C	70	А
I <sub>C</sub> <sup>(1)</sup>	Collector current (continuous) at 100 °C	40	А
I <sub>CL</sub> <sup>(2)</sup>	Turn-off latching current	230	А
I <sub>CP</sub> <sup>(3)</sup>	Pulsed collector current	230	A
$V_{GE}$	Gate-emitter voltage	±20	V
P <sub>TOT</sub>	Total dissipation at $T_C = 25 \ ^{\circ}C$	250	W
Тj	Operating junction temperature	- 55 to 150	°C
1. Calculate	d according to the iterative formula:		
$I_{C}(T_{C}) = \frac{1}{R_{THJ}}$	$\frac{T_{JMAX} - T_{C}}{-C \times V_{CESAT(MAX)} (T_{C}, I_{C})}$	Ste .	
2. Vclamp =	80%(V <sub>CES</sub> ), Tj = 150 °C, R <sub>G</sub> = 10 Ω, V <sub>GE</sub> 15 γ		

$$I_{C}(T_{C}) = \frac{T_{JMAX} - T_{C}}{R_{THJ-C} \times V_{CESAT(MAX)}(T_{C}, I_{C})}$$

2. Vclamp = 80%(V\_{CES}), Tj = 150 °C, R\_G = 10  $\Omega,$  V\_{GE} 15  $\checkmark$ 

3. Pulse width limited by max. junction temperature allowed

#### Table 3. Thermal resistance

	Symbol	Parameter	Value	Unit
	R <sub>thj-case</sub> Therman resistance junction-case max		0.5	°C/W
	R <sub>thj-amb</sub>	Therinal resistance junction-ambient max	50	°C/W
Obsole	ter			

#### **Electrical characteristics** 2

(T<sub>CASE</sub>=25 °C unless otherwise specified)

Table 4.	Static
	olulio

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)CES</sub>	Collector-emitter breakdown voltage ( $V_{GE} = 0$ )	I <sub>C</sub> = 1 mA	600			v
V <sub>CE(sat)</sub>	Collector-emitter saturation voltage	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 30 A V <sub>GE</sub> = 15 V, I <sub>C</sub> = 30 A, T <sub>C</sub> =125 °C		2.1 1.9	2.5	v v
V <sub>GE(th)</sub>	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 250 \mu A$	3.75		5.75	V
I <sub>CES</sub>	Collector-emitter cut-off current (V <sub>GE</sub> = 0)	V <sub>GE</sub> = 600 V V <sub>GE</sub> = 600 V, T <sub>C</sub> =125 °C	6	20	500 5	μA mA
I <sub>GES</sub>	Gate-emitter cut-off current (V <sub>CE</sub> = 0)	V <sub>GE</sub> = ± 20 V			±100	nA
9 <sub>fs</sub>	Forward transconductance	V <sub>CE</sub> = 15 V, I <sub>C</sub> = 30 A		20		S
		SOL				
Table 5.	Dynamic	$\sim$				
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit

#### Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>ies</sub> C <sub>oes</sub> C <sub>res</sub>	Input capacitance Output capacitance Reverse trai sfer capacital ce	V <sub>CE</sub> = 25 V, f = 1 MHz, V <sub>GE</sub> = 0		2900 298 59		pF pF pF
Q <sub>g</sub> Q <sub>ge</sub> Q <sub>jc</sub>	ic⁺al gate charge Gate-emitter charge Gate-collector charge	$V_{CE}$ = 390 V, I <sub>C</sub> = 30 A, $V_{GE}$ = 15 V (see Figure 17)		126 16 46		nC nC nC
psolet		1		II		

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V}, I_C = 30 \text{ A}$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V}$ (see Figure 16)		33 12 2600		ns ns A/µs
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 390 \; V, \; I_C = 30 \; A \\ R_G = 10 \; \Omega, \; V_{GE} = 15 \; V, \\ T_C = 125 \; ^\circ C \\ \textit{(see Figure 16)} \end{array}$		32 14 2300		ns ns A/µs
t <sub>r</sub> (V <sub>off</sub> ) t <sub>d</sub> ( <sub>off</sub> ) t <sub>f</sub>	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V}, I_C = 30 \text{ A},$ $R_{GE} = 10 \Omega, V_{GE} = 15 \text{ V}$ <i>(see Figure 16)</i>		26 168 06	9	ns ns ns
t <sub>r</sub> (V <sub>off</sub> ) t <sub>d(off</sub> ) t <sub>f</sub>	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V}, I_C = 30 \text{ A},$ $R_{GE}=10 \Omega, V_{GE} = 15 \text{ V}$ $T_C=125 \text{ °C} (see Figure 16)$		54 213 67		ns ns ns

Table 6. Switching on/off (inductive load)

### Table 7. Switching energy (inductive load)

Symbol	Parameter	Test condition	ns Min	Тур.	Max	Unit
E <sub>on</sub> <sup>(1)</sup> E <sub>off</sub> <sup>(2)</sup> E <sub>ts</sub>	Turn-on switching losses Turn-off switching lossจร Total switching lossอร	$V_{CC} = 390 \text{ V}, \text{ I}_{C} = 30 \text{ R}_{G} = 10 \Omega, \text{ V}_{GE} = 15$ (see Figure 16)		302 349 651		μJ μJ μJ
E <sub>on</sub> <sup>(1)</sup> E <sub>off</sub> <sup>(2)</sup> E <sub>i</sub>	Turn-ch switching losses Turn-of: switching losses Total switching losses	$V_{CC} = 390$ V, I <sub>C</sub> = 30 R <sub>G</sub> = 10 Ω, V <sub>GE</sub> = 15 T <sub>C</sub> = 125 °C (see Figure 16)		553 750 1303		μJ μJ μJ

For n is the turn-on losses when a typical diode is used in the test circuit in figure 2 Eon include diode recovery energy. If the IGBT is offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & diode are at the same temperature (25 °C and 125 °C)

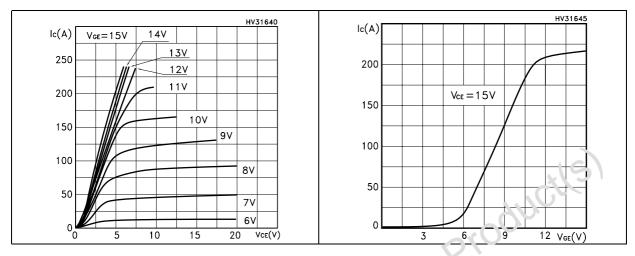
2. Turn-off losses include also the tail of the collector current



### 2.1 Electrical characteristics (curves)

### Figure 2. Output characteristics

Figure 3. Transfer characteristics





Vce=15V

g fs(S)

18

15

12

с

Figure 5.



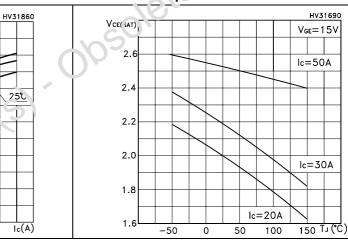


Figure S.

Collector-emitter on voltage vs collector current

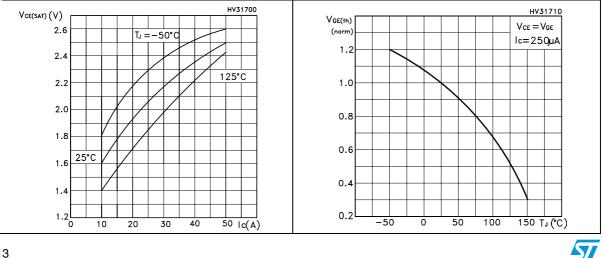
10

T」=−50°C

150°C

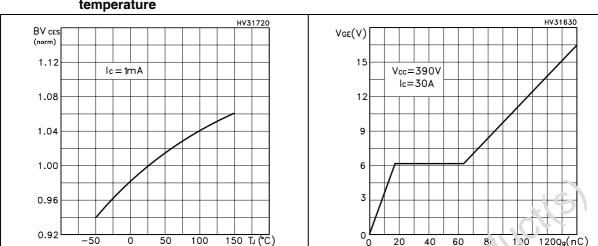
15

Figure 7. Normalized gate threshold vs temperature

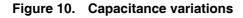


8) 1.0 120Qg(nC)

5

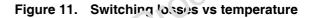


#### Figure 8. Normalized breakdown voltage vs Figure 9. Gate charge vs gate-emitter voltage temperature



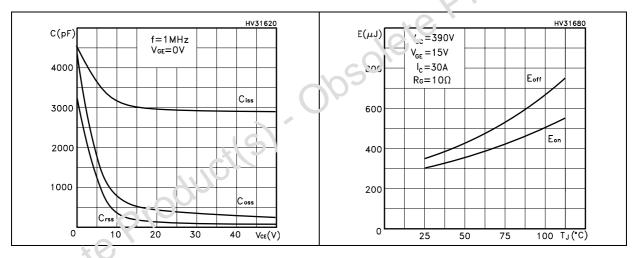
0

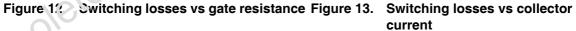
50

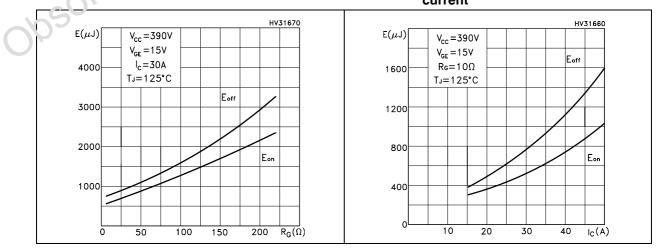


60

40

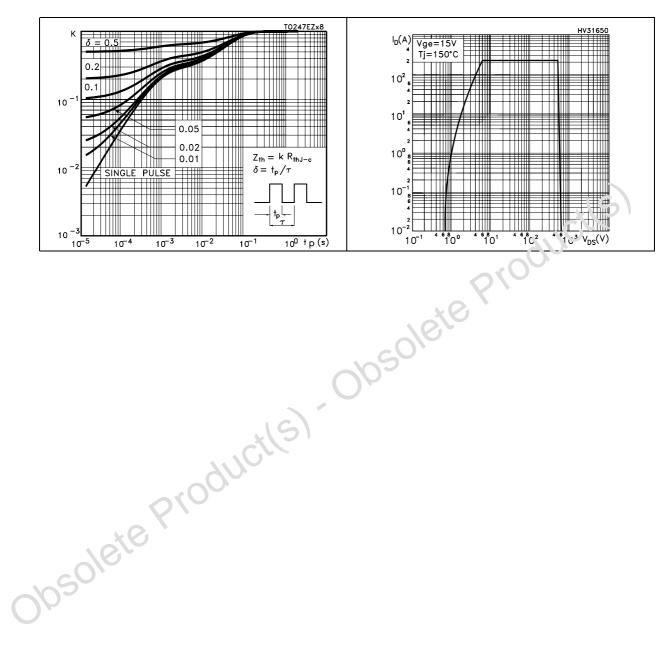






### Figure 14. Thermal impedance

### Figure 15. Turn-off SOA





#### **Test circuit** 3

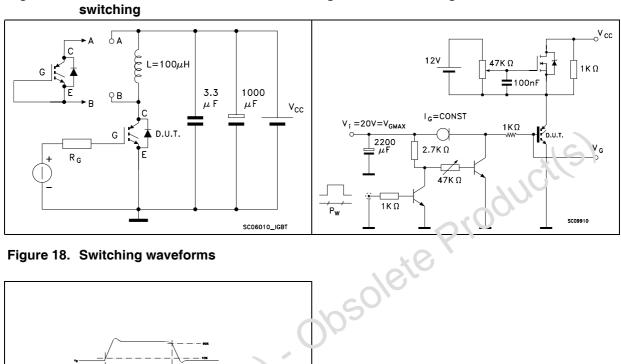
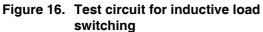


Figure 17. Gate charge test circuit



210501e

### 4 Package mechanical data

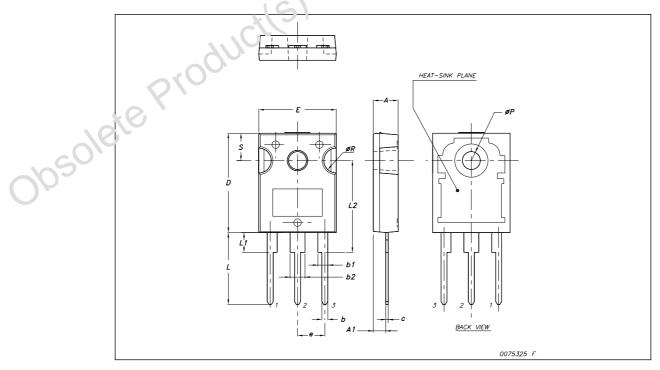
In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: *www.st.com* 

obsolete Product(s). Obsolete Product(s)



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TO-247 Mechanical data				
Dim.	mm.			
5	Min.	Тур	Max.	
A	4.85		5.15	
A1	2.20		2.60	
b	1.0		1.40	
b1	2.0		2.40	
b2	3.0		3.40	
С	0.40		050	
D	19.85		२८.15	
E	15.45		15.75	
е		5.45		
L	14.20		14.80	
L1	3.70		4.30	
L2		18.50		
øP	3.55	105	3.65	
øR	4.50	De	5.50	
S	_ /	5.50		



# 5 Revision history

### Table 8.Document revision history

Date	Revision	Changes
09-Jul-2008	1	First release

obsolete Product(s). Obsolete Product(s)



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